

Line Number	Hits	Search Text	DB	Time stamp
1	1	5945969.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
7	1	5945969.pn. and frame	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
13	1	5945969.pn. and support	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:26
19	0	5945969.pn. and joint fit	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
25	1	5945969.pn. and ledge	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
31	13	ando-yoichi.in. and emitter	USPAT; US-PGPUB; EPO; JPO; DEWENT; IBM_TDB	2003/07/17 11:47
38	5	ando-yoichi.in. and emitter and 'surround\$4 encircled\$4 circled\$4'	USPAT; US-PGPUB; EPO; JPO; DEWENT; IBM_TDB	2003/07/17 11:47
45	5	ando-yoichi.in. and emitter and 'surround\$4 encircled\$4 circled\$4'	USPAT; US-PGPUB; EPO; JPO; DEWENT; IBM_TDB	2003/07/17 11:50
52	8	(ando-yoichi.in. and emitter) not (ando-yoichi.in. and emitter and 'surround\$4 encircled\$4 circled\$4')	USPAT; US-PGPUB; EPO; JPO; DEWENT; IBM_TDB	2003/07/17 11:50
141	1	6509691.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12
147	0	6509691.pn. and (surround\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12
153	0	6509691.pn. and (encircled\$4 circled\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
165	1	20030102798.did. and (surround\$4 encircled\$4 circled\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
169	1	20030102798.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
171	1	20030102798.did. and surround\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
177	1	20030102798.did. and apart from	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:19

149	0	5913108.pn. and "33"	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 12:19
149	1	5913108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:16
190	090	serigraphy	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:16
211	0	20030102798.did. and second adj. conductive adj. film	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:21
212	1	20030102798.did. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:21
213	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:21
219	1	20020005692.did. and second adj. conductive adj. film	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/17 13:21
-	905	(313/495).CCLS.	USPAT; US-PGPUB	2003/07/17 11:24
-	109	ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/16 12:45
-	2	hyperspeed.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:32
-	1	lightspeed.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:33
-	10	hyper same antenna.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:33
-	30	ando-yoichi.in. and image adj. forming	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/17 11:46
-	984	(313/495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 19:41
-	905	(313/495).CCLS.	USPAT; US-PGPUB	2003/01/31 19:41
-	860	(313/495).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	0	"114 not 115".EN.	USPAT; US-PGPUB	2003/01/31 19:42
-	444	"114" not (313/495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 19:42

-	200	313 496 .CCLS. not 313 495 .CCLS.	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:47
-	2	5463108.pn.	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:48
-	0	546788.URFN.	USPAT	2003/01/31 11:48
-	162	pixtech.as.	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:01
-	299279	5903108.pn. spacer	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:06
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:16
-	0	5463276.pn. and image	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:16
-	4	5463276.pn. 4899081.pn. 5270613.pn. and image	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:17
-	1	(5463276.pn. 4899081.pn. 5270613.pn.) and image	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:17
-	1105	((313/496) or (313/495)).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	755	(313/493).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	0	("198 not 195").FN.	USPAT; US-PGPUB	2003/01/31 11:28
-	729	((313/493).CCLS.) not (((313/496) or (313/495)).CCLS.)	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:30
-	193	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.) and display	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:30
-	50	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.) and display and image	USPAT; US-PGPUB; EPC; JPC; DERWENT; IBM_TDB	2003/01/31 11:37
-	939	(313 634).CCLS.	USPAT; US-PGPUB	2003/01/31 11:43
-	5	("5508584" "5543491" "5561345" "55614751" "5567026").FN.	USPAT	2003/01/31 11:37
-	1	5903108.URFN.	USPAT	2003/01/31 11:47
-	1434	(313 493 or 313 495 or 313 496).CCLS.	USPAT; US-PGPUB	2003/01/31 11:43
-	0	("1125 not 1133").FN.	USPAT; US-PGPUB	2003/01/31 11:43

-	1	20020005690.did. and 27P	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:33
-	1	20020005690.did. and longitudinal	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:34
-	1	20020005690.did. and longitudinal with end same discharge	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:35
-	1	20020005690.did. and longitudinal with end same suppressing	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:36
-	1	20020005690.did. and longitudinal with end	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:16
-	1	20020005690.did. and conductive adj film with "6" same surface	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:19
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:23
-	1	5903108.pn. and ring track same (film coat\$ layer\$4)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:30
-	0	5903108.pn. and (closed adj loop)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4 same (track ring)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:36
-	1	5903108.pn. and bias\$4 same (track ring" same cathode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:06
-	79	jones-gary-w.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	34	jones-gary-w.in. and zimmerman-steven-m.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn. and "340"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18
-	0	20020005690.did. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18

-	1	20030706P1.dia. and surround ring conductive anode film	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:18
-	1	09031.8.08PM.	USPAT	2003/07/16 19:18
-	1144	anode same surround ring encircle circle and image display panel	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:19
-	17	surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:19
-	17	surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:19
-	17	((surround\$5 ring encircle circle\$4) with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate and surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer)	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:19
-	262	surround\$5 ring encircle circle\$4 with anode electrode same conducting conductive metallic near3 (film coat layer) and substrate and image and (display panel image).ab,ti.	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:17
-	60	((surround\$5 ring encircle circle\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circle\$4) with (image with display panel) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with (image with display panel) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:20
-	60	((surround\$5 ring encircle circle\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and ((surround\$5 ring encircle circle\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4) with (image with (display panel) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with (image with (display panel) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPC; JPO; IBM_TDB	2003/07/16 19:21

-	13	surround\$5 ring encircle circle\$4 near4 (phosphor anode electrode near4 phosphor) with (conducting conductive metallic near3 (film coat layer) and (surround\$5 ring encircle circle\$4 near4 (phosphor anode electrode with (conducting conductive metallic near3 (film coat layer) and substrate and image and (display panel image .ab,ti. not (surround\$5 ring encircle circle\$4 with (image with (display panel) same (conducting conductive metallic near3 (film coat layer) and substrate and surround\$5 ring encircle circle\$4 with (image with (display panel) same (conducting conductive metallic near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:13
-	14	(surround\$5 ring encircle circle\$4 near4 (phosphor anode electrode near4 phosphor) with (conducting conductive metallic metal near3 (film coat layer and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:24
-	14	(surround\$5 ring encircle circle\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:25
-	14	(surround\$5 ring encircle circle\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and ((surround\$5 ring encircle circle\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:46
-	22	guard adj ring near6 anode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47
-		guard adj ring near6 anode and image and (display panel .ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47

board adj ring near13 and image and
display panel .ab,ti.

USPAT;
US-IPRIB;
EP; JIS;
IBM_TLB

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